

Abstract

Provided is a container-type data center capable of properly cooling an electronic apparatus to be cooled according to the amount of heat generated by the electronic apparatus. A container-type data center (1) comprises: a container body (2); a liquid immersion container (5) which is provided inside the container body (2), and in which is stored a cooling liquid into which an electronic apparatus is immersed and cooled; an air-cooling rack (6) that is provided inside the container body (2), and through which cooling air passes; and a water-cooling rack (7) that is provided inside the container body (2), and that is provided with a water-cooled heat sink installed in contact with a heat-generating part of the electronic apparatus.